



STDD15 series

LOW CAPACITANCE DETECTION DIODE

MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	10 mA
V_{RRM}	15 V
T_j (max)	150 °C
V_F (max)	0.51 V

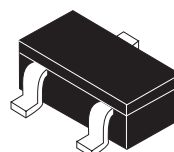
FEATURES AND BENEFITS

- Low diode capacitance
- Device designed for RF application
- Low profile package
- Available in 3 configurations
- Very low parasitic inductor & resistor

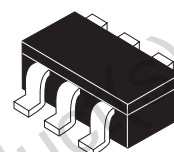
DESCRIPTION

The STDD15 is a dual diode series for the detection of a RF signal and the compensation of the voltage drift with the temperature. The SOT323 package makes the device ideal in application where the space saving is critical like mobile phones.

The low junction capacitance will reduce the disturbance on the RF signal

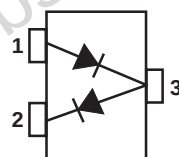


SOT323-3L
STDD15-xxW

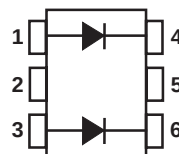


SOT323-6L
STDD15-xxS

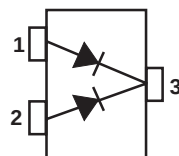
SCHEMATIC DIAGRAM



Series configuration
STDD15-04W



Parallel configuration
STDD15-07S



Common cathode configuration
STDD15-05W

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		15	V
I_F	Continuous forward current		10	mA
I_{FSM}	Surge non repetitive forward current	$t_p = 10ms$	2	A
T_{stg}	Storage temperature range		- 65 + 150	°C
T_j	Maximum operating junction temperature		150	°C

STDD15 series

THERMAL PARAMETERS

Symbol	Parameter	Value	Unit
$R_{th(j-a)}^*$	Junction to ambient	500	°C/W

*: Mounted with minimum recommended pad size, PC board FR4.

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I_R^*	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = 1\text{V}$			0.035	μA
		$T_j = 125^\circ\text{C}$			6	30	
		$T_j = 25^\circ\text{C}$	$V_R = 15\text{V}$			0.23	μA
		$T_j = 125^\circ\text{C}$			10	100	
V_F^*	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 1\text{mA}$		350	380	mV
		$T_j = 125^\circ\text{C}$			230	260	
		$T_j = 25^\circ\text{C}$	$I_F = 10\text{mA}$		500	570	
		$T_j = 125^\circ\text{C}$			450	510	

* Pulse test: $t_p \leq 250\mu\text{s}$, $\Delta \leq 2\%$

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
C	Diode capacitance	$V_R = 0\text{V}$	$F = 1\text{MHz}$			1.0	pF
R_F	Forward resistance	$I_F = 5\text{mA}$	$F = 100\text{MHz}$		15		Ω
Ls	Series inductance				1.5		nH

Fig. 1: Forward voltage drop versus forward current (typical values).

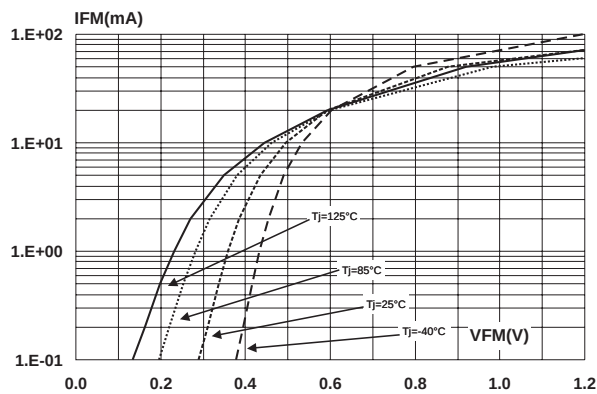


Fig. 2: Reverse leakage current versus reverse voltage applied (typical values).

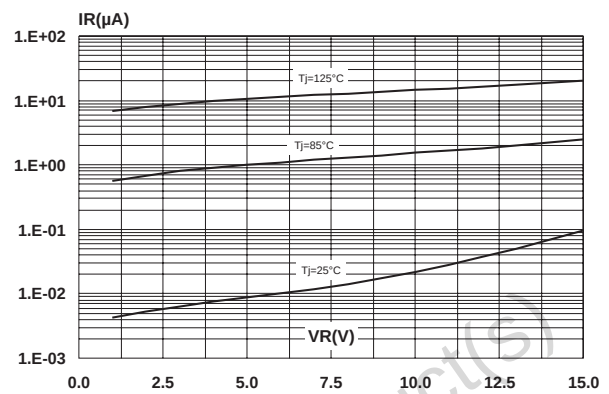


Fig. 3: Differential forward resistance versus forward current (typical values).

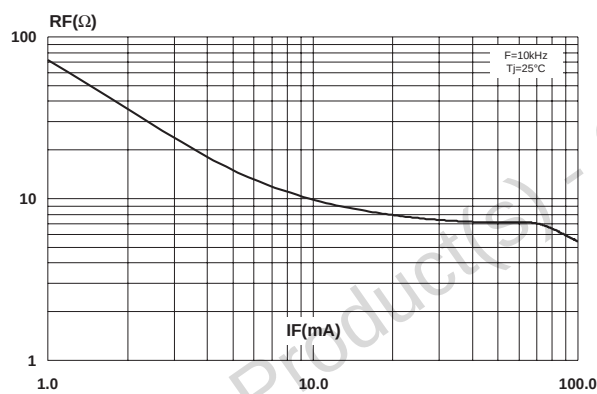


Fig. 4: Junction capacitance versus reverse voltage applied (typical values).

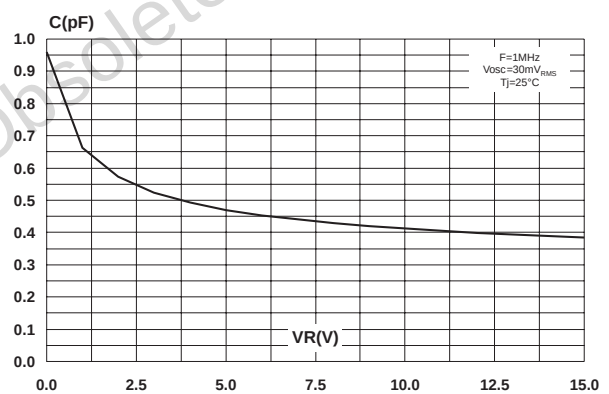


Fig. 5: Variation of thermal impedance junction to ambient versus pulse duration (printed circuit board, epoxy FR4).

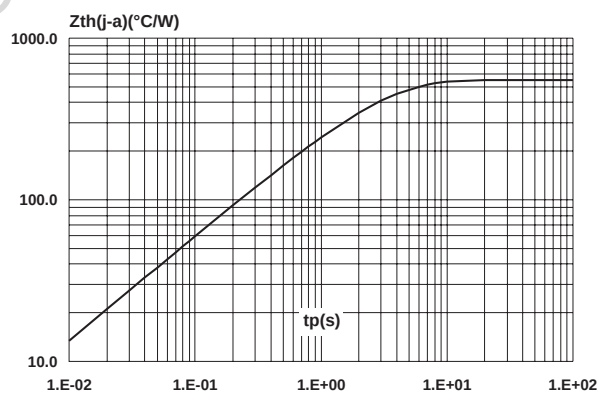
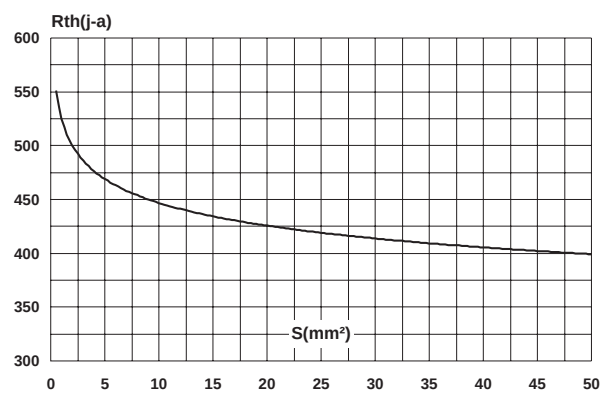


Fig. 6: Thermal resistance junction to ambient versus copper surface under each lead (printed circuit board, epoxy FR4).



STDD15 series

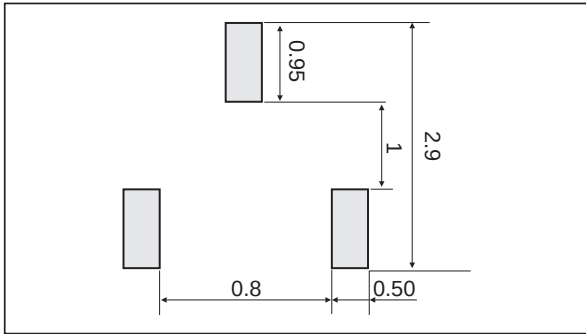
Electrical Model (PSPICE)

Parameter	Value	Unit
Is	2.66 e-8	A
N	1.04	
M	0.772	
Vj	0.65	V
Eg	0.69	eV
Xti	2	
Rs	15	W
Cjo	0.85 e-12	F
Bv	20	V
Ibv	10 e-3	A

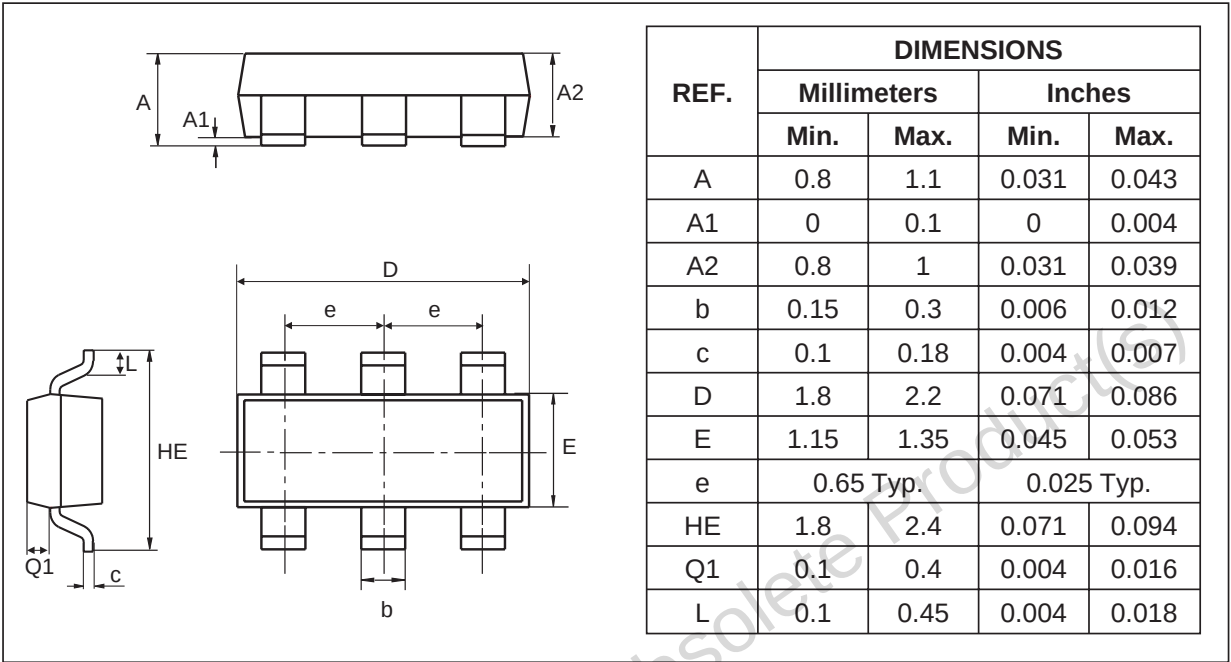
PACKAGE MECHANICAL DATA
SOT323-3L

REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.8		1.1	0.031		0.043
A1	0.0		0.1	0.0		0.004
b	0.25		0.4	0.010		0.016
c	0.1		0.26	0.004		0.010
D	1.8	2.0	2.2	0.071	0.079	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e		0.65			0.026	
H	1.8	2.1	2.4	0.071	0.083	0.094
L	0.1	0.2	0.3	0.004	0.008	0.012
θ	0		30°	0		30°

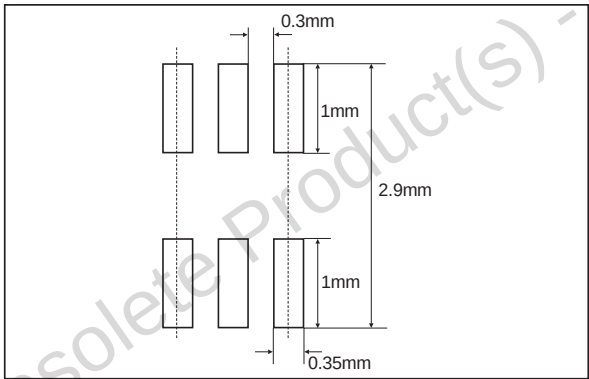
FOOTPRINT (in millimeters)



PACKAGE MECHANICAL DATA
SOT323-6L



FOOTPRINT (in millimeters)



Note: The device fulfills the MSL level 1 after leadfree soldering profile.

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
STDD15-04W	24	SOT323-3L	0.006 g	3000	Tape & reel
STDD15-05W	25	SOT323-3L	0.006 g	3000	Tape & reel
STDD15-07S	D25	SOT323-6L	0.006 g	3000	Tape & reel

Obsolete Product(s) - Obsolete Product(s)

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